

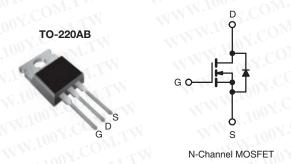
RoHS

COMPLIANT

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	100			
$R_{DS(on)}(\Omega)$	V _{GS} = 5.0 V 0.0			
Q _g (Max.) (nC)	64	OMITW		
Q _{gs} (nC)	9.4	WIM		
Q _{gd} (nC)	27	COPT		
Configuration	Singl	le COM		



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- R_{DS(on)} Specified at V_{GS} = 4 V and 5 V
- 175 °C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	MAN TOO S. COM'LAN AMAN TOO COM'S AND AND TOO S. COM'S AND AND TOO S. COM'S AND T. COM'S AND T	
Package	TO-220AB	
Lead (Pb)-free	IRL540PbF	
	SiHL540-E3	
SnPb	IRL540	
OHED COMPANY	SiHL540	N

ABSOLUTE MAXIMUM RATINGS (TC	= 25 °C, unless otherwis	se noted)			
PARAMETER	MAN W. COA. CO	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	TWW. Toward C	V_{DS}	100	COM	
Gate-Source Voltage		V_{GS}	± 10	V	
Continuous Drain Current	$T_C = 25 ^{\circ}C$	WILL	28	MO.	
Continuous Drain Current V_{GS} at 5.0 V $T_{C} = 100 ^{\circ}\text{C}$		COMP	20	CA	
Pulsed Drain Current ^a	100°	I _{DM}	110		
Linear Derating Factor		TIME	1.0	W/°C	
Single Pulse Avalanche Energy ^b	WWW.	E _{AS}	440	mJ	
Avalanche Current ^a		I _{AR}	28	A	
Repetitive Avalanche Energy ^a		E _{AR}	15	mJ	
Maximum Power Dissipation	T _C = 25 °C	P_{D}	150	W	
Peak Diode Recovery dV/dtc		dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range	ge	T _J , T _{stg}	- 55 to + 175	≪C	
Soldering Recommendations (Peak Temperature)	for 10 s	. OUT.CO	300 ^d	100	
Mounting Torque	6-32 or M3 screw	W. In	10	lbf ⋅ in	
Mounting Torque	0-32 OF IVIS SCIEW	100 Y.	1.1	N·m	

- WW.100Y.COM.TW a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 841 μ H, R_g = 25 Ω , I_{AS} = 28 A (see fig. 12c).
- c. $I_{SD} \le 28 \text{ A}$, $dI/dt \le 170 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 175 \text{ °C}$.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



Vishay Siliconix	OM.TW COM.TW	M.M.M.100X.C.		
THERMAL RESISTANCE RAT	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-WW.Inc	62	
Case-to-Sink, Flat, Greasd Surface	R _{thCS}	0.50	CON	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	W -W.	1.0	

SPECIFICATIONS (T _J = 25 °C, u	100	1 -	TOONDITIONS	NAIN!	TVD	BAAY	
PARAMETER	SYMBOL	IES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	1. P. CC		MAIN	J	N	ı	1
Drain-Source Breakdown Voltage	V_{DS}		= 0 V, I _D = 250 μA	100	KN -	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C, I _D = 1 mA	COM.	0.12	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}		V_{GS} , $I_D = 250 \mu A$	1.0	17.72	2.0	V
Gate-Source Leakage	I _{GSS}	TIM	$V_{GS} = \pm 10 \text{ V}$		T.T.M	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		100 V, V _{GS} = 0 V	V.	WILL	25	μΑ
al M. I. a COMP.	-555	$V_{DS} = 80 \text{ V},$	$V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$	ov.CC	-	250	ļ
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 5.0 \text{ V}$	I _D = 17 A ^b	√v C	$O_{M_{\overline{1}}}$	0.077	Ω
State Please and State	1 103(011)	$V_{GS} = 4.0 \text{ V}$	$I_D = 14 A^b$	100	OPA	0.11	
Forward Transconductance	9 _{fs}	V _{DS} = 50 V, I _D = 17 A		12	MOD	7.47	S
Dynamic	WWW	1100¥.CO	THE WALL	T 100Y		LTW	
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. } 5$		100	2200	FW	
Output Capacitance	Coss			M.T.	560		pF
Reverse Transfer Capacitance	C _{rss}			MA TO	140	DNF.	(N)
Total Gate Charge	Q_g	M.100 ONI.1.		1. W. V.	00 -	64	nC
Gate-Source Charge	Q_{gs}	$V_{GS} = 5.0 \text{ V}$	$V_{GS} = 5.0 \text{ V}$ $I_D = 28 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 ^b		$100_{\overline{A}}$	9.4	
Gate-Drain Charge	√ Q _{gd} ≺	1003	CONTAIN	MAG	1001	27	TW
Turn-On Delay Time	t _{d(on)}	WWW.	Y.COM TW	Man	8.5	1.00	TI
Rise Time	t _r	V_{DD} = 50 V, I_{D} = 28 A, R_{g} = 9.0 Ω, R_{D} = 1.7 Ω, see fig. 10 ^b		WW	170	Z.EO	ns
Turn-Off Delay Time	t _{d(off)}				35	~-CC	
Fall Time	t _f	W		_	80	10 ×	MO
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		- 1	4.5	001.	cO ^N
Internal Source Inductance	O L _S			-	7.5	1 1 <u>0</u> 07	, c'O
Drain-Source Body Diode Characteristic	SOM	WW	M. TODY.COM		MM	1100	N.C.
Continuous Source-Drain Diode Current	CO Is	MOSFET symbol showing the		N -		28	OV.
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		W.	-11	110	002
Body Diode Voltage	V _{SD}	T _J = 25 °C	$I_{S} = 28 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	T.	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 28 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^b$		LIM	200	260	ns
Body Diode Reverse Recovery Charge	Q_{rr}			NEIN	1.7	2.90	μC
Forward Turn-On Time	t _{on} CO	Intrinsic tu	on is dor	minated b	v L _s and	[P]	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

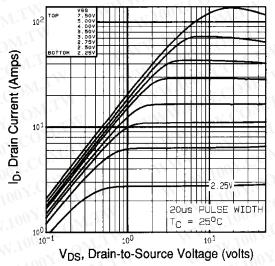


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

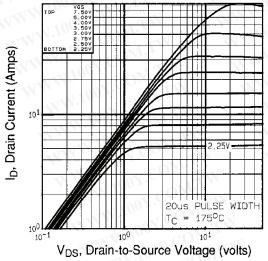


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

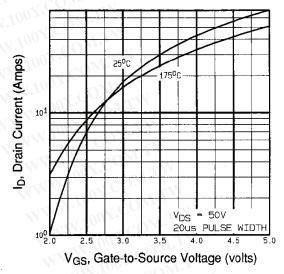


Fig. 3 - Typical Transfer Characteristics

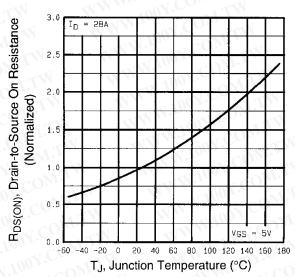


Fig. 4 - Normalized On-Resistance vs. Temperature



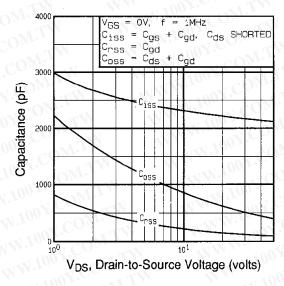


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

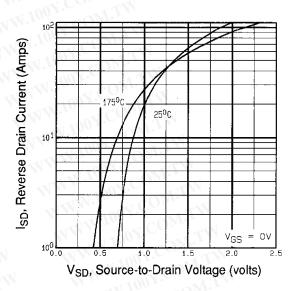


Fig. 7 - Typical Source-Drain Diode Forward Voltage

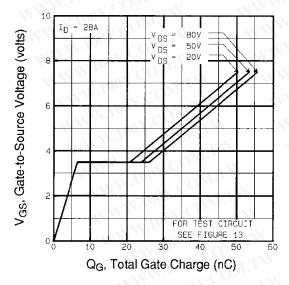


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

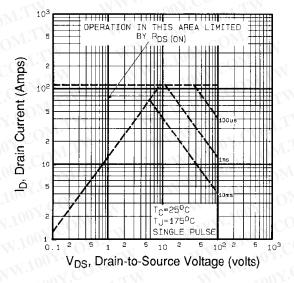


Fig. 8 - Maximum Safe Operating Area





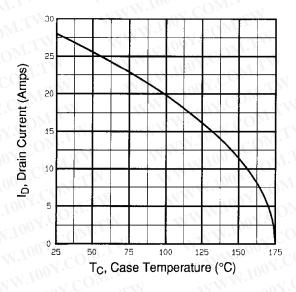


Fig. 9 - Maximum Safe Operating Area

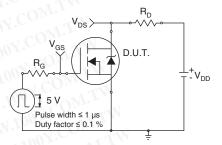


Fig. 10a - Switching Time Test Circuit

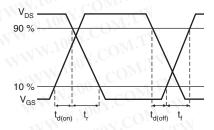


Fig. 10b - Switching Time Waveforms

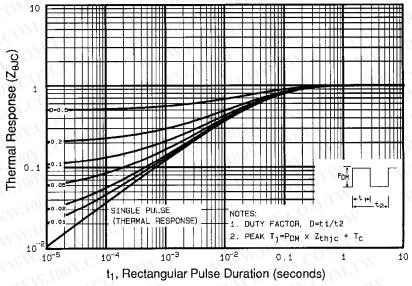


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



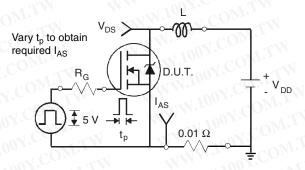


Fig. 12a - Unclamped Inductive Test Circuit

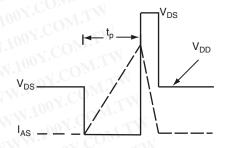


Fig. 12b - Unclamped Inductive Waveforms

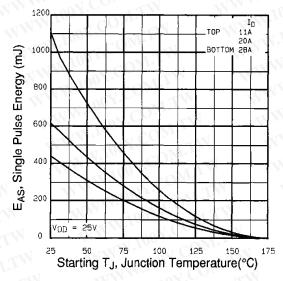


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

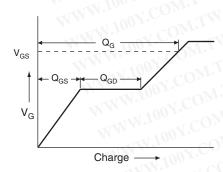


Fig. 13a - Basic Gate Charge Waveform

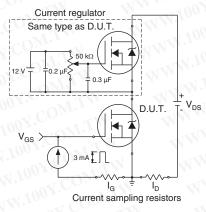
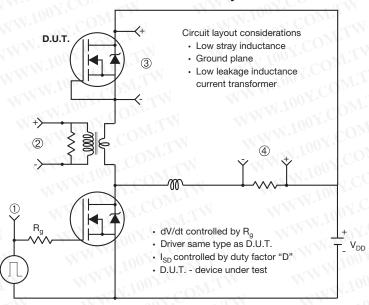


Fig. 13b - Gate Charge Test Circuit





Peak Diode Recovery dV/dt Test Circuit



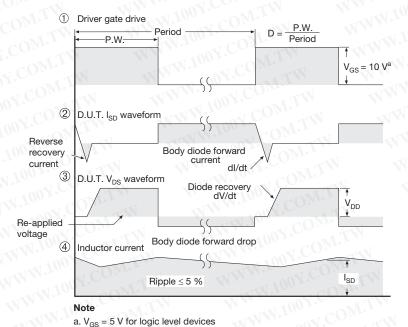
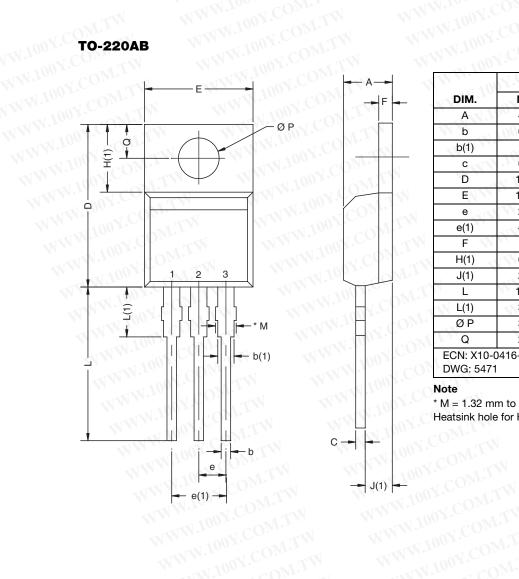


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91300.



TO-220AB



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M. 44.700	MILLIN	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX	
A	4.25	4.65	0.167	0.18	
b	0.69	1.01	0.027	0.04	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
ENV	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.10	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.05	
H(1)	6.09	6.48	0.240	0.25	
J(1)	2.41	2.92	0.095	0.11	
L	13.35	14.02	0.526	0.552	
(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.15	
Q	2.60	3.00	0.102	0.118	

DWG: 5471

Note

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* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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